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SUBMISSION TYPE:	BMISSION TYPE: NEW ASSIGNMENT			
NATURE OF CONVEYANCE:		ASSIGNMENT		
CONVEYING PARTY	DATA	·		
Name			Execution Date	
HSIEN-HUNG SU			01/09/2020	
SEOK-LYUL LEE			12/10/2019	
YEN-HUANG HSU			12/10/2019	
Street Address: Citv:	HSINC	HU		
City: State/Country:	HSINC TAIWA			
City:	TAIWA			
City: State/Country:	TAIWA			
City: State/Country: PROPERTY NUMBER	TAIWA RS Total: 1 pe	N		
City: State/Country: PROPERTY NUMBER Property Typ	TAIWA RS Total: 1 be	N Number		

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

usa@jcipgroup.com
JCIPRNET
8F-1, NO. 100, ROOSEVELT RD. SEC. 2,
TAIPEI CITY, TAIWAN 10084

ATTORNEY DOCKET NUMBER:	089973-US-PA
NAME OF SUBMITTER:	BELINDA LEE
SIGNATURE:	/Belinda Lee/
DATE SIGNED:	01/30/2020
Total Attachments: 1	·

Total Attachments: 4

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DECLARATION AND ASSIGNMENT

FOR UTILITY OR DESIGN PATENT APPLICATION

Declaration Submitted With Initial Filing

OR

Declaration Submitted After Initial Filing (surcharge 37 CFR 1.16(f) required)

(Title of the Invention)

LIQUID CRYSTAL PANEL AND MANUFACTURING METHOD THEREOF

As a below named inventor (hereinafter designated as the undersigned), I hereby

declare that:

This declaration is directed to:

The attached application,

OR

United States Application Number or PCT International application number

The above-identified application was made or authorized to be made by me.

Filed on

I believe I am the original inventor or an original joint inventor of a claimed invention in the application.

The undersigned hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

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DECLARATION AND ASSIGNMENT

FOR UTILITY OR DESIGN PATENT APPLICATION

WHEREAS, the undersigned has invented certain new and useful improvements described in the application identified.

WHEREAS,

 Au Optronics Corporation
No. 1, Li-Hsin Rd. II, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring the undersigned's interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by the undersigned, the undersigned has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said rights, title and interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said the undersigned had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

The undersigned further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain

or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

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DECLARATION AND ASSIGNMENT

FOR UTILITY OR DESIGN PATENT APPLICATION

Signature:	Hsien-Hung	Su	_Date:_	10.10.000	A
Legal Name of S	ole or First Inventor: Hsier	I-Hung Su		÷.	CP .
Residence: Hsind	chu, Taiwan				
Mailing Address:	c/o No. 1, Li-Hsin Rd. II, S	cience-Based Indus	trial Park	, Hsinchu, Taiwan, R.O.C	2. 2.
Signature:			Date:		
-	dditional Joint Inventor, if a			NG P	-
Residence: Hsind					
Mailing Address:	c/o No. 1, Li-Hsin Rd. II, S	cience-Based Indust	rial Park	, Hsinchu, Taiwan, R.O.C	
			MÖ.	, , , , , , , , , , , , , , , , , , , ,	
Cimentum					
Residence: Hsinc	dditional Joint Inventor, if a	iny: Yen-Huang Hsu	l		
		D			
Walling Address.	c/o No. 1, Li-Hsin Rd. II, S	cience-Based Indust	rial Park	, Hsinchu, Taiwan, R.O.C	

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DECLARATION AND ASSIGNMENT

FOR UTILITY OR DESIGN PATENT APPLICATION

Signature:	Date:	
Legal Name of Sole or First Inventor: Hsien-Hung Su		
Residence: Hsinchu, Taiwan		
Mailing Address: c/o No. 1, Li-Hsin Rd. II, Science-Based	Industrial Park, Hsinchu, T	aiwan, R.O.C.
		× *
Signature: Seok Lynl. Lee	Date: <u>10</u> Dec	. 2019
Legal Name of Additional Joint Inventor, if any: Seok-Lyu	I Lee	/
Residence: Hsinchu City, Taiwan		
Mailing Address: c/o No. 1, Li-Hsin Rd. II, Science-Based	Industrial Park, Hsinchu, Ta	aiwan, R.O.C.
Signature: Yen Huang How	Date: 10 Dec	2019
Legal Name of Additional Joint Inventor, if any: Yen-Huan		
Residence: Hsinchu, Taiwan	19 1130	
Mailing Address: c/o No. 1, Li-Hsin Rd. II, Science-Based	Industrial Park Heinchu Ta	aiwan ROC
		awan, n.o.o.

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RECORDED: 01/30/2020